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(54) **SUPPORTING CALIBRATION FOR
SUB-RATE OPERATION IN CLOCKED
MEMORY SYSTEMS**

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(58) **Field of Classification Search**

None

See application file for complete search history.

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(56) **References Cited**

U.S. PATENT DOCUMENTS

6,735,709 B1 * 5/2004 Lee G01R 31/31937
702/89

2002/0133666 A1 9/2002 Janzen et al.

2005/0163202 A1 7/2005 Hampel et al.

2010/0202227 A1 8/2010 Nguyen et al.

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This patent is subject to a terminal dis-
claimer.

OTHER PUBLICATIONS

International Preliminary Report on Patentability dated Nov. 21,
2013 in International Application No. PCT/US2012/036370. 9
pages.

International Search Report and Written Opinion dated Jul. 26, 2012
in International Application No. PCT/US2012/036370. 12 pages.

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* cited by examiner

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6, 2011.

(51) **Int. Cl.**

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G06F 1/10 (2006.01)

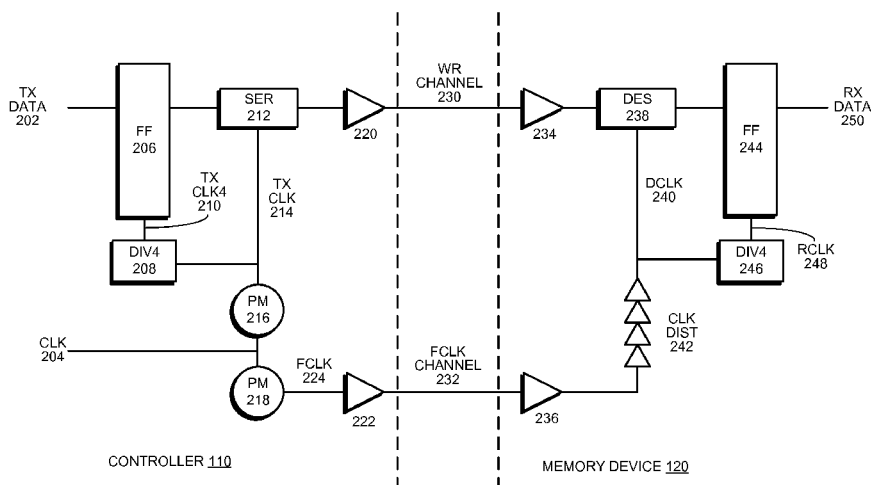
(52) **U.S. Cl.**

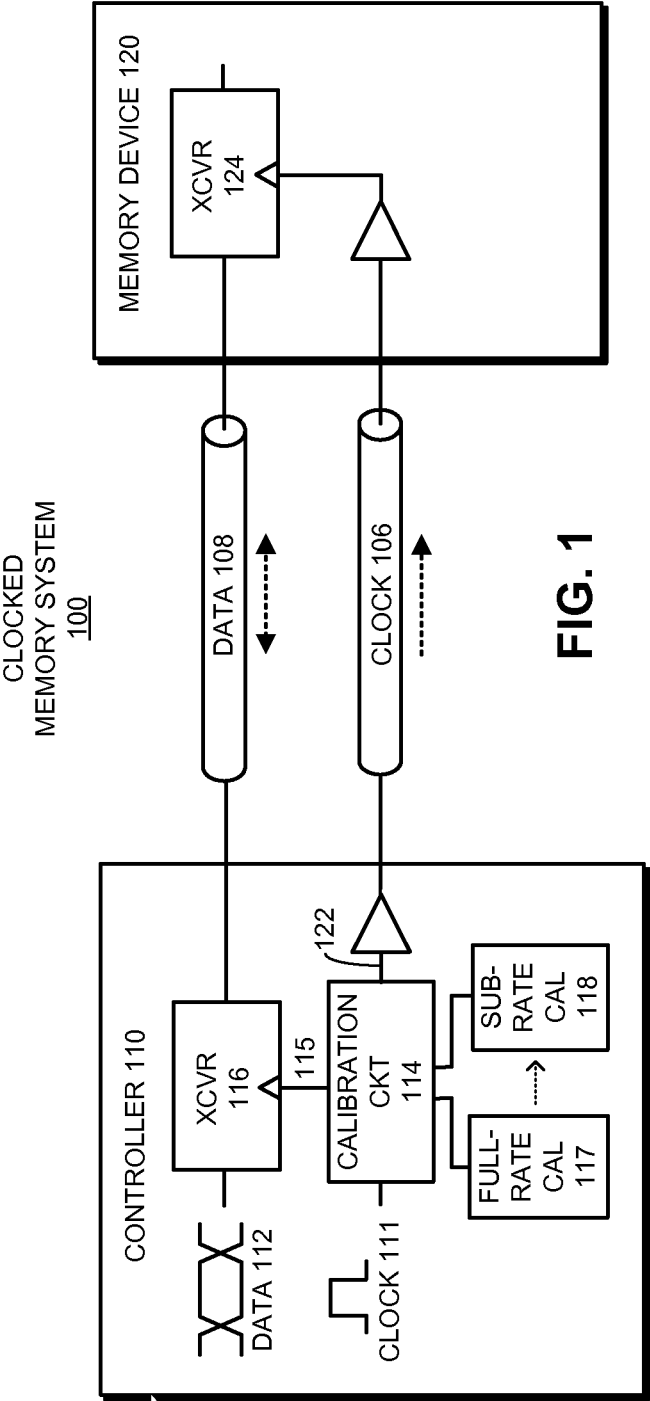
CPC .. *GIIC 7/22* (2013.01); *G06F 1/10* (2013.01);

(57) **ABSTRACT**

The disclosed embodiments related to a clocked memory system which performs a calibration operation at a full-rate frequency to determine a full-rate calibration state that specifies a delay between a clock signal and a corresponding data signal in the clocked memory system. Next, the clocked memory system uses the full-rate calibration state to calculate a sub-rate calibration state, which is associated with a sub-rate frequency (e.g., $\frac{1}{2}$, $\frac{1}{4}$ or $\frac{1}{8}$ of the full-rate frequency). The system then uses this sub-rate calibration state when the clocked memory system is operating at the sub-rate frequency. This calculation of the sub-rate state calibration states eliminates the need to perform an additional time-consuming calibration operation for each sub-rate.

20 Claims, 6 Drawing Sheets





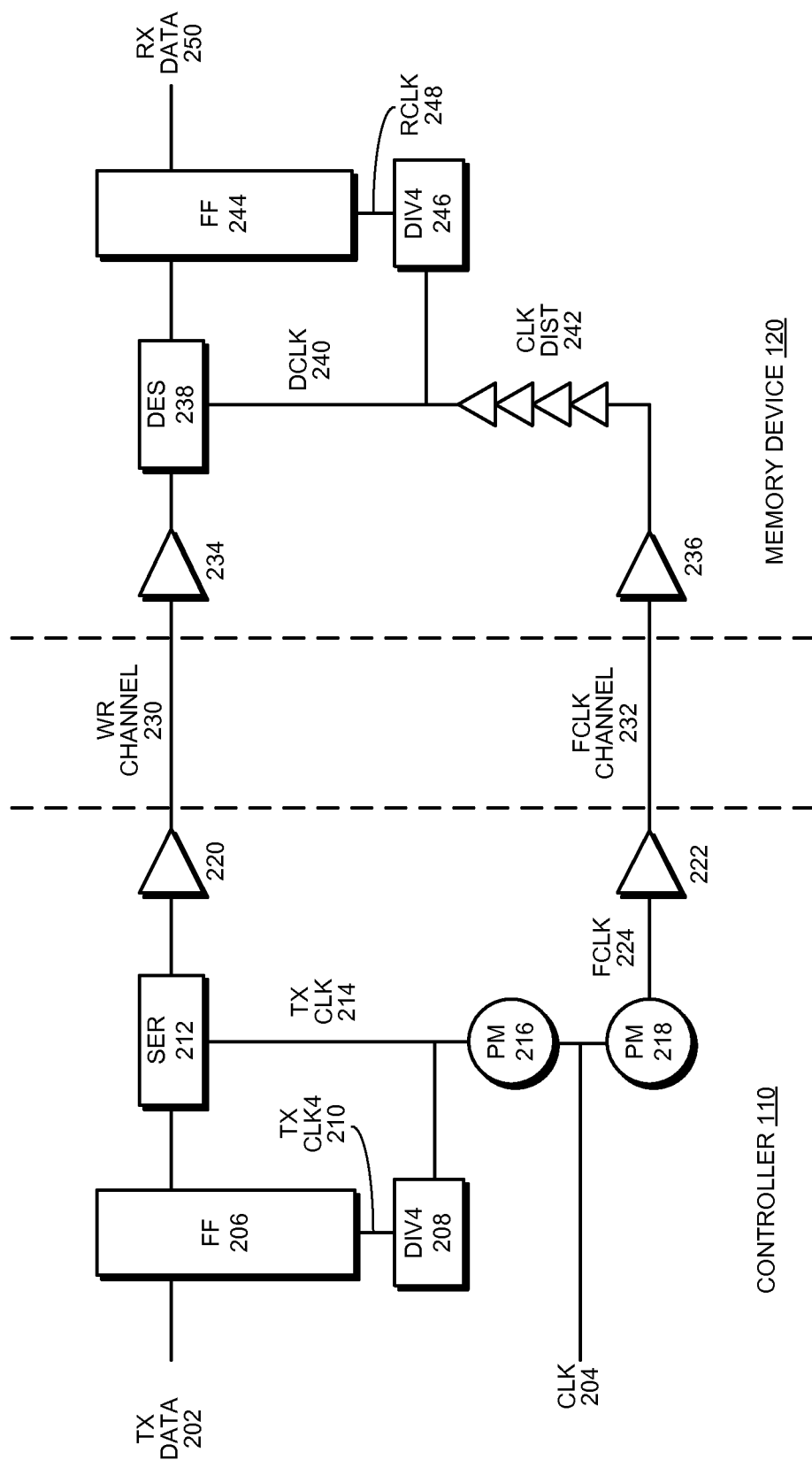


FIG. 2

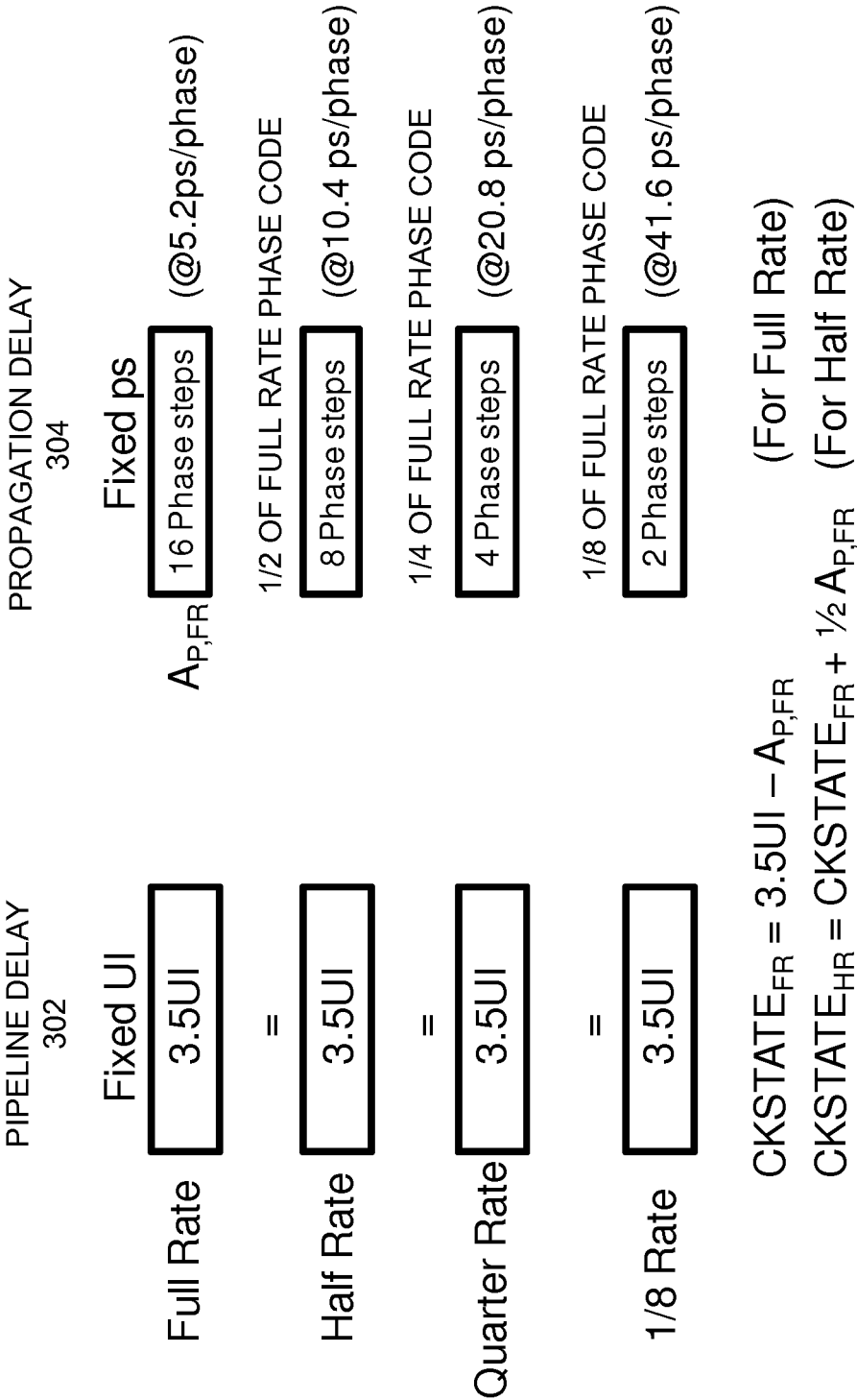


FIG. 3

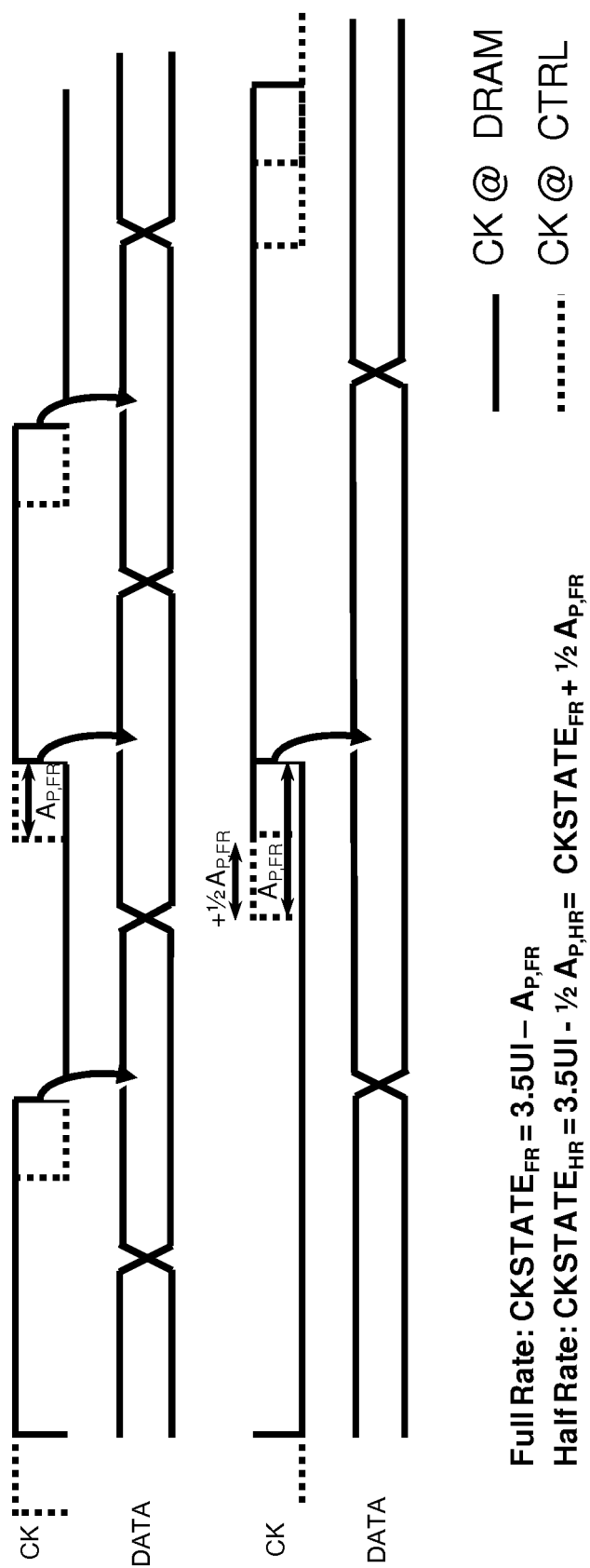


FIG. 4

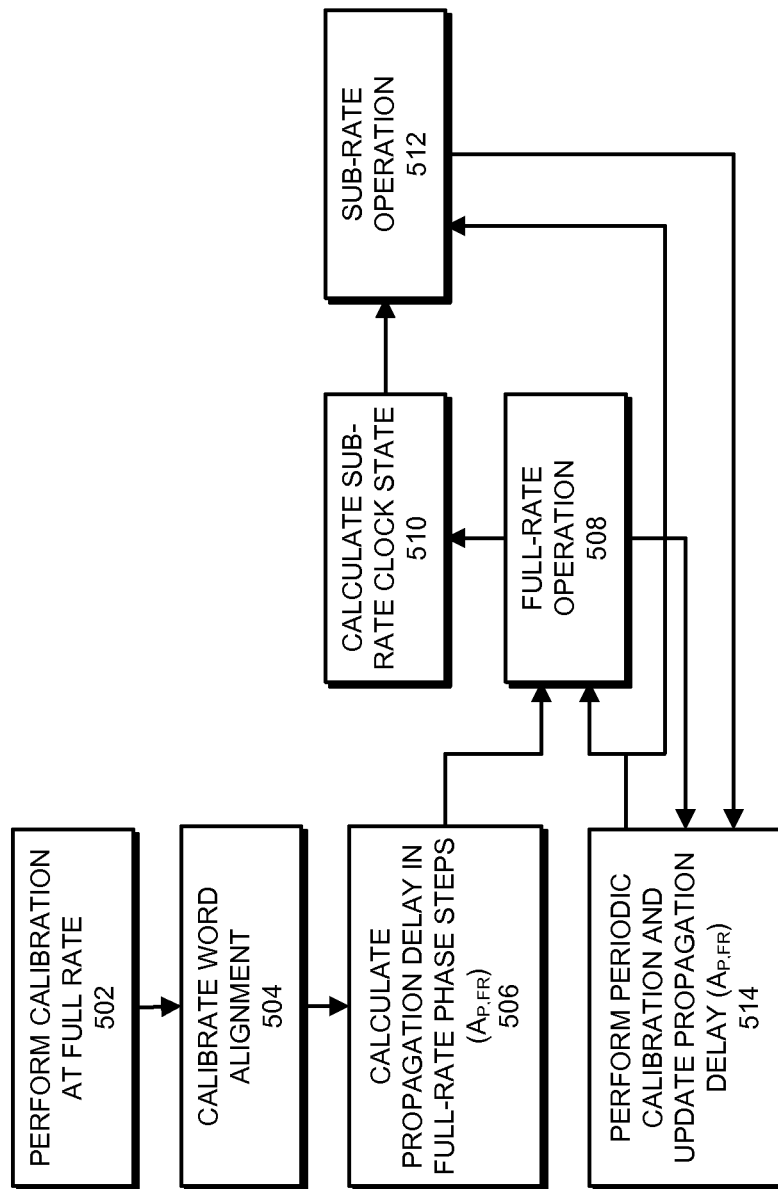
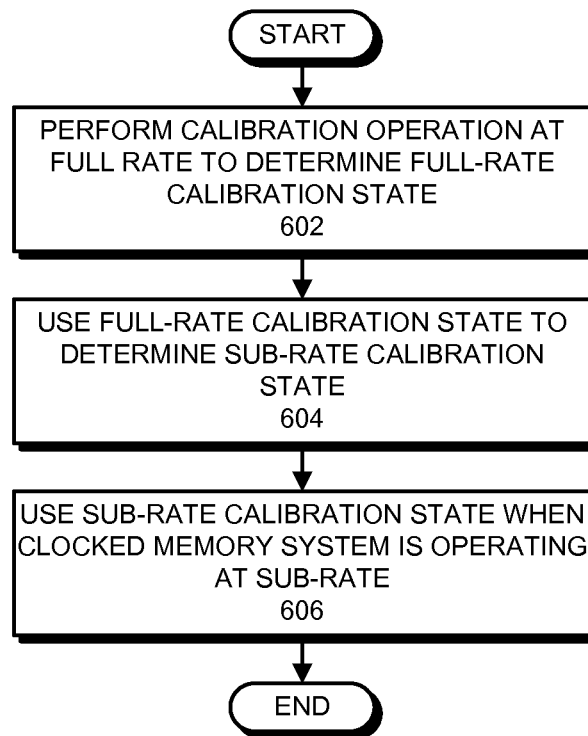
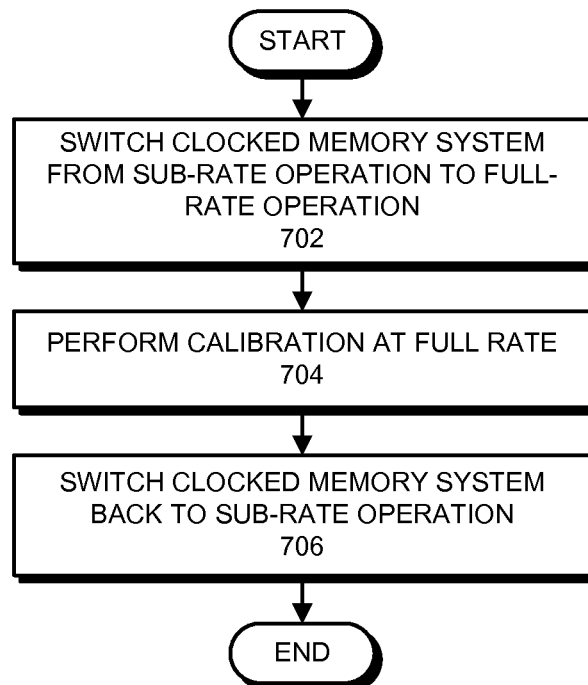


FIG. 5

**FIG. 6****FIG. 7**

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SUPPORTING CALIBRATION FOR SUB-RATE OPERATION IN CLOCKED MEMORY SYSTEMS

CROSS-REFERENCE TO RELATED APPLICATIONS

This patent application is a continuation of U.S. Utility application Ser. No. 13/982474, filed on Jul. 29, 2013 for "Supporting Calibration For Sub-Rate Operation In Clocked Memory Systems" which, in turn, is a national stage entry under 35 USC §371 of PCT Application No. PCT/US2012/036370 which, in turn, claims benefit to U.S. Provisional Application No. 61/483,558, filed May 6, 2011. The aforementioned applications are hereby incorporated by reference herein in their entirety.

BACKGROUND

1. Field

The disclosed embodiments generally relate to clocked memory systems. More specifically, the disclosed embodiments relate to a technique for supporting calibration for full-rate and sub-rate operation in low-power clocked memory systems.

2. Related Art

Mobile computing systems typically operate at reduced clock frequencies when computational workloads are low. These reduced clock frequencies make it possible to decrease power consumption, which can significantly extend battery life. As the clock frequency of a mobile computing system decreases, the operating frequency of an associated clocked memory system needs to decrease proportionately. In existing calibrated memory systems (such as systems using extreme data rate (XDR) or double-data rate (DDR) memory interfaces) this typically involves performing a recalibration operation to ensure that the clocked memory system continues to function optimally at the decreased operating frequency. This is particularly important because as clock frequencies are reduced, the calibration setting will change because of frequency dependent delay and jitter in the system, which creates the need for additional timing margin so that the system is correctly calibrated for data sampling during lower frequency operation. Hence, in high-speed calibrated memory systems, the bit sampling phase and word alignment settings need to be changed when the frequency changes. Note that systems which use fixed delay lines have suboptimal settings (with equal or lower timing margins) at lower operating frequencies. Unfortunately, this recalibration operation is time-consuming which can adversely affect memory system performance, and can make it less attractive to reduce clock frequencies for short periods of time.

Hence, what is needed is a technique that facilitates reducing the operating frequency of a memory system without the need to perform a time-consuming recalibration operation.

BRIEF DESCRIPTION OF THE FIGURES

FIG. 1 illustrates a clocked memory system in accordance with the disclosed embodiments.

FIG. 2 illustrates a transmitter and receiver circuit in accordance with the disclosed embodiments.

FIG. 3 illustrates pipeline and propagation delays in accordance with the disclosed embodiments.

FIG. 4 presents a timing diagram illustrating half-rate and full-rate clocking in accordance with the disclosed embodiments.

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FIG. 5 presents a flow chart illustrating the calibration process in accordance with the disclosed embodiments.

FIG. 6 presents a flow chart illustrating how the sub-rate calibration state is computed in accordance with the disclosed embodiments.

FIG. 7 presents a flow chart illustrating how calibration takes place at a full rate in accordance with the disclosed embodiments.

DETAILED DESCRIPTION

The disclosed embodiments relate to the design of a clocked memory system that supports full-rate operation at a full-rate clock frequency as well as sub-rate operation at one or more sub-rate frequencies. While the clocked memory system is operating, the clocked memory system performs a calibration operation at the full-rate clock frequency to determine a full-rate calibration state that specifies a delay between a clock signal and a corresponding data signal in the clocked memory system. Next, the clocked memory system uses the full-rate calibration state to calculate a sub-rate calibration state, which is associated with a sub-rate frequency (e.g., $\frac{1}{2}$, $\frac{1}{4}$ or $\frac{1}{8}$ of the full-rate frequency). The system then uses this sub-rate calibration state while the clocked memory system is operating at the sub-rate frequency. Note that the calculation of the sub-rate state calibration state eliminates the need to perform an additional time-consuming calibration operation for each sub-rate.

Clocked Memory System

Referring to FIG. 1, a clocked memory system 100 includes a memory controller 110 that communicates with at least one memory device 102 through a bi-directional data path 108 and a clock path 106. During operation of clocked memory system 100, data signals 112 are transferred between a transceiver (XCVR) 116 on controller 110 and a corresponding transceiver (XCVR) 124 on a memory device 120 through data path 108. More specifically, during write operations, data is transmitted from transceiver 116 in controller 110 to transceiver 124 in memory device 120. Similarly, during read operations, data is transferred in the other direction from transceiver 124 in memory device 120 to transceiver 116 in controller 110.

These data transfers are synchronized by a clock signal 111, which feeds into a calibration circuit 114 within controller 110. Calibration circuit 114 generates a controller clock signal 115 that feeds into XCVR 116 and a memory clock signal 122, which feeds through clock path 106 to XCVR 124 within memory device 120.

Calibration circuit 114 makes use of a full-rate calibration state 117 to determine the appropriate delay between controller clock signal 111 and memory clock signal 122, and also the appropriate delay between controller clock signal 111 and controller clock signal 115, for both read and write operations during full-rate operation of clocked memory system 100. (Note that full-rate calibration state 117 and a sub-rate calibration state 118 can be stored in registers within controller 110.) Similarly, during sub-rate operation (e.g., $\frac{1}{2}$, $\frac{1}{4}$ or $\frac{1}{8}$ rate), calibration circuit 114 makes use of one or more sub-rate calibration states 118 to determine associated read and write delays. Note that clocked memory system 110 calculates the sub-rate calibration states 118 from full-rate calibration state 117 (as is described below) without having to perform additional sub-rate calibrations at other clock rates.

The circuitry presented in FIG. 1 is illustrated in more detail in FIG. 2, which presents circuitry involved in calibrating a write operation. (Note that similar circuitry is involved in performing a read operation, except that the data is trans-

ferred in the reverse direction through the data channel.) During a write operation, which starts at controller **110**, an eight-bit data word from transmit data **202** is clocked into a flip-flop (FF) **206** using a divided clock signal TX CLK **4 210**. Next, this eight-bit data word feeds into a serializer (SER) **212**, which operates under control of a clock signal TX CLK **214** and converts the eight-bit data word into a serial bit stream, which feeds through driver **220** onto a write channel **230**. (Note that write channel **230** can be implemented as part of the bi-directional data channel **108** that is illustrated in FIG. 1.) The serial data stream from write channel **230** feeds into a receiver **234** within memory device **120** and then into a deserializer (DES) **238**. Deserializer **238** uses a clock signal DCLK **240** to de-serialize the data stream to produce an eight-bit data word, which is clocked into a flip-flop **244** by a clock signal RCLK **248**. Flip-flop **244** then outputs the eight-bit data word as receive data (RX DATA) **250**, which can be written to a location within memory device **120**.

During this write operation, much of the circuitry illustrated in FIG. 2 is used to synchronize and calibrate various clock signals. More specifically, within controller **110**, a reference clock signal **204** feeds into two phase mixers (PMs) **216** and **218**, which are each controlled by a calibration input (not shown). Phase mixer **216** generates clock signal TX CLK **214**, which feeds into serializer **212**. TX CLK signal **214** also feeds through a clock divider DIV **4 208** to produce divided clock signal **210**, which is used to latch data words into flip-flop **206**. The other phase mixer **218** generates a clock signal FCLK **224**, which feeds into a driver **222** and is thus driven across a FCLK channel **323** and into a receiver **236** within memory device **120**. Receiver **236** drives the received clock signal through a clock distribution network (CLK DST) **242** into deserializer **238**, which uses the received clock signal to de-serialize the received eight-bit data word. The received clock signal also feeds through a clock divider DIV **4 246** to produce divided clock signal RCLK **248**, which is used to latch data words into flip-flop **244**. Flip-flop **244** outputs receive data (RX DATA) **250**, which can then be written into a location within memory device **120**.

Pipeline Delay and Propagation Delay

The clock and data signals illustrated in FIG. 2 are associated with two different types of delay components. (1) There are clock-rate-dependent “pipeline delay” components, which depend on the number of pipeline stages that these signals flow through. (2) There are also substantially clock-rate-independent “propagation delay” components (also referred to as “analog delays”), which for example can include channel delays, clock buffer delays, driver delays and receiver delays. In one embodiment, the data path in the upper portion of FIG. 2 includes a 3 UI (unit interval, e.g., a clock cycle of clock **204**) clock-rate-dependent pipeline delay through serializer **212**, a substantially clock-rate-independent propagation delay through write channel **230** (including driver and receiver delays), and an 8.5 UI clock-rate-dependent delay through DES **238**. (Note that this 8.5 UI delay includes eight UI to wait for the eight serial bits to be received, and then 0.5 UI to wait for the center of the data eye.) The corresponding clock path includes substantially clock-rate-independent propagation delays through both FCLK channel **232** (including driver and receiver delays) and clock distribution network **242**.

In this embodiment, the total analog propagation delay approximately equals (1) the delay through FCLK channel **232**+(2) the clock distribution delay through clock distribution network **242**–(3) the delay through write channel **230**, and can be quantized as a number of “phase steps” (where N phase steps=1 UI, with N set, for example, to 64). Moreover,

the corresponding total pipeline delay equals (1) 3 UI through serializer **212**+(2) 8.5 UI through deserializer **238**, which equals 11.5 UI. (Note that because the word alignment is separately calibrated and the word size is eight bits, the 11.5 UI pipeline delay is reduced modulo 8 to 3.5 UI)

Hence, the full-rate calibration state for the clocked memory system is essentially the difference between the controller calibration state and the memory device calibration state, which equals the 3.5 UI pipeline delay—the total propagation delay.

When the clocked memory system switches from the full rate to a sub-rate, the 3.5 UI pipeline delay remains the same as the clock rate decreases. The propagation delay expressed in seconds remains essentially the same, however, which can be a problem if the delay components for calibration states are aggregated as a fixed number of clock periods. In the present embodiment, the number of increments accounting for the propagation delay is tracked separate from the pipeline delay and reduced proportionately with the clock period. For example, FIG. 3 illustrates the adjustments to the calibration state that are used to produce various sub-rate calibration states (for $\frac{1}{2}$ rate, $\frac{1}{4}$ rate and $\frac{1}{8}$ rate) from a full-rate calibration state. As is illustrated in FIG. 3, the 3.5 UI pipeline delay **302** remains unchanged for each sub rate. (Note, however, that because the clock period increases for each sub-rate, the actual pipeline delay measured in picoseconds increases for each sub rate.)

In contrast to the pipeline delay **302**, the propagation delay **304** (as expressed in number of UI) decreases as the clock period increases to keep the total propagation delay as measured in picoseconds constant. For example, assume that each UI is divided into 64 phase steps and that the total full-rate propagation delay **304** starts out at 16 phase steps. In this case, the number of phase steps drops to 8, 4 and 2 as the sub-rate drops to $\frac{1}{2}$, $\frac{1}{4}$ and $\frac{1}{8}$, respectively. (Note that a corresponding “calibration state” can be encoded using 9 bits, which includes 3 bits to encode up to 8 UI of integer delay, and 6 bits to encode 64 phase step offsets.)

Also note that similar delay values and calibration states are computed for the read path. For example, in the read path, the total analog propagation delay approximately equals (1) the delay through FCLK channel+(2) the delay through read channel+(3) the delay through clock distribution network. Note that after a read path calibration state calculation, there is a chance that the read path will be bit locked, but not properly word aligned. In this case, to complete the calibration process, the system can perform an additional read path word alignment operation. Hence, in general, if the read path or write path analog delays are longer than one word, then word-alignment calibration is needed. Moreover, if word alignment has been performed to account for a larger than one-word delay, then the resulting calibration settings can be used to calculate new calibration settings for different frequencies. For example, if the analog delay was set to 16 UI+16 phase steps, then at half rate, the corresponding settings would be 8 UI+8 phase steps. Note that the word-alignment logic can remove a parallel word pipeline stage.

FIG. 4 presents a timing diagram that illustrates how the calibration state adjustment operates when the clocked memory system transitions from operating a full rate to half rate. (Note that the fixed analog propagation delay in increments of full-rate clock period phase steps is represented as $A_{P,FR}$.) In this diagram, the full rate calibration state $KSTATE_{FR}=3.5\text{ UI}-A_{P,FR}$. Because each half-rate phase step is double the duration of a full-rate phase step, to keep the propagation delay constant, the $-A_{P,FR}$ term needs to be multiplied by $\frac{1}{2}$. Hence, the half-rate calibration state

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$CKSTATE_{HR}=3.5 \text{ UI}-\frac{1}{2}A_{P,FR}=CKSTATE_{FR}+\frac{1}{2}A_{P,FR}$. As can be seen from the timing diagram illustrated in FIG. 4, adding this $\frac{1}{2}A_{P,FR}$ term to $CKSTATE_{FR}$ effectively moves the clock edge to the center of the half-rate data eye.

Calibration Process

FIG. 5 presents a flow chart illustrating a calibration process in accordance with one disclosed embodiment. At the start of the process, the clocked memory system performs a calibration at the full clock rate (step 502). The system also calibrates word alignment (step 504). As mentioned above, this word alignment calibration can potentially introduce a modulo eight calculation into the calibration state computation.

The system additionally computes the analog propagation delay $A_{P,FR}$ in full-rate phase steps at step 506. In one embodiment, a known pipeline delay is stored in a register, and is subtracted from an observed total delay to estimate analog delay. In another embodiment, calibration at two or more rates is performed back-to-back, and a delay versus rate intercept point is calculated to set the pipeline delay. Because the analog delay does not change, but pipeline delay is proportional to rate, two measurements at two known frequencies allow calculation of both pipeline and analog delay. Next, the system commences full-rate operation using this full-rate calibration state (step 508).

At a later time, when the system determines (for example, based on system load) that it is advantageous to commence sub-rate operation, the system first calculates the sub-rate calibration state from the full-rate calibration state (step 510). As mentioned above, this can involve leaving the pipeline delay (expressed in clock period increments) the same, and adjusting the analog propagation delay (expressed in clock period phase steps) $A_{P,FR}$ based on the increase in clock period. For example, for $\frac{1}{2}$ -rate operation $A_{P,FR}$ is divided by 2, for $\frac{1}{4}$ -rate operation $A_{P,FR}$ is divided by 4, and for $\frac{1}{8}$ -rate operation $A_{P,FR}$ is divided by 8. Next, the system commences sub-rate operation using the computed sub-rate calibration state (512). In an alternative embodiment, during the initial calibration process, a full-rate calibration is performed. Also, sub-rate calibration states are calculated from full-rate calibration state, and the sub-rate calibration states are stored in registers. These sub-rate calibration states are then periodically updated by performing periodic calibration operations to compensate for drift.

The system also periodically performs a calibration operation. For example, after a specific time interval (e.g., one millisecond), the system can go from either full-rate operation 508 or sub-rate operation 512 to a calibration state to perform a periodic calibration operation and to update the analog propagation delay $A_{P,FR}$ (step 514). (Note that this periodic calibration is performed at the full clock rate.) The system then returns to either full rate operation 508 or half rate operation 510.

FIG. 5 can be modified in some embodiments. For instance, step 506 can calculate and store in registers all sub-rate clock states, which can then be indexed and used immediately upon rate changes. The step 514 periodic calibration can likewise recalculate and store all sub-rate clock states.

In a given embodiment, periodic calibration may be performed at the current clock rate rather than the full rate. For instance, recalibration of a half rate analog propagation delay $A_{P,HR}$ when operating at half rate can be used to set other propagation delays. For full-rate operation $A_{P,HR}$ is multiplied by 2, for $\frac{1}{4}$ -rate operation $A_{P,HR}$ is divided by 2, and for $\frac{1}{8}$ -rate operation $A_{P,HR}$ is divided by 4. The system may not allow recalibration at a lower rate to set a calibration state for

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a significantly higher rate—in other words, a recalibration performed at $\frac{1}{4}$ or $\frac{1}{8}$ rate may invalidate the full-rate calibration state, requiring that a half-rate or full rate calibration be performed before transitioning back to full rate.

In summary, the system avoids having to perform calibration operations for the each sub-rate by performing a calibration operation at, e.g., the full rate, and then using the results of the full-rate calibration to compute calibration parameters for the sub-rates. More specifically, as shown in FIG. 6, the system first performs a calibration operation at the full rate to determine a full-rate calibration state (step 602). The system uses the full-rate calibration state to determine a sub-rate calibration state (604). Finally, the system uses the sub-rate calibration state while the clock memory system is operating at the sub-rate (606).

Moreover, in one embodiment the system switches back to the full rate or a higher rate to perform periodic calibration operations. For example, as shown in FIG. 7, when the system is initially operating at a sub-rate, the system first switches the clocked memory system to operate at the full rate (step 702). Next, the system performs the calibration operation at the full rate (step 704) and then switches the clocked memory system back to operating at the sub rate (step 706). Note that switching to the sub rate involves first using the new full-rate calibration state to compute a new sub-rate calibration state.

Also note that instead of re-computing the pipeline delay for each sub-rate, the system can alternatively include a lookup table, which contains a baseline delay for each sub-rate, and this baseline delay can be added to a “drift tracking” delay element which is determined during the periodic full-rate calibration, or alternatively during a sub-rate calibration. More specifically, the system can perform initial calibration operations at a plurality of frequencies, including a full-rate frequency and associated sub-rate frequencies, to determine initial calibration states (baseline delays) for each of the frequencies. Next, the system can perform a subsequent calibration operation at a first frequency in the plurality of frequencies to determine a current calibration state for the first frequency, wherein the current calibration state includes a drift component that indicates how far the current calibration state for the first frequency has drifted from the initial calibration state for the first frequency. This drift component enables the system to quickly determine a current calibration state for a second frequency in the plurality of frequencies based on the drift component and the initial calibration state for the second frequency. Next, the system can use the current calibration state for the second frequency when the clocked memory system is operating at the second frequency.

Although binary sub-rates have been used to illustrate the embodiments, possible applications are not so limited. The memory controller need not be informed of the actual rates or expressly perform the calibration states. For instance, the current full-rate calibration state information can be placed in a host-processor-accessible register, with the host processor calculating and storing the appropriate sub-rate calibration state in another host-processor-accessible register at the time the host processor commands a rate change to the memory controller.

This disclosure recognizes that although analog delays are similar at different clock rates and will similarly track variations in temperature and voltage, small differences may exist that are not modeled in the base embodiment. For instance, slew rate limiting of drivers, channels, receivers, etc. may cause slightly different observed analog delay at higher rates. It is believed that these second order effects can be ignored in most embodiments, as the overall analog delay remains substantially the same at all rates, and the second-order effects

may not even produce a different phase step at a slower rate. Thus “clock rate independent” as used herein recognizes that a parameter treated as clock rate independent may not be strictly independent of clock rate, but can be so modeled for purposes of an embodiment. A given embodiment can, how-
 5 ever, attempt to model analog delay versus rate variation and factor such variation into the settings. For instance, full-rate and half-rate calibration operations can be performed back-to-back at system initialization, with the phase step obtained for the half-rate calibration compared to a half-rate phase step
 10 obtained by calculation from the calibrated full-rate phase step. If these two half-rate phase steps differ, a constant offset can be saved and used in runtime transitions between the rates.

The preceding description was presented to enable any person skilled in the art to make and use the disclosed embodiments, and is provided in the context of a particular application and its requirements. Various modifications to the disclosed embodiments will be readily apparent to those skilled in the art, and the general principles defined herein
 20 may be applied to other embodiments and applications without departing from the spirit and scope of the disclosed embodiments. Thus, the disclosed embodiments are not limited to the embodiments shown, but are to be accorded the widest scope consistent with the principles and features disclosed herein. Accordingly, many modifications and variations
 25 will be apparent to practitioners skilled in the art. Additionally, the above disclosure is not intended to limit the present description. The scope of the present description is defined by the appended claims.

Also, some of the above-described methods and processes can be embodied as code and/or data, which can be stored in a computer-readable storage medium as described above. When a computer system reads and executes the code and/or
 35 data stored on the computer-readable storage medium, the computer system performs the methods and processes embodied as data structures and code and stored within the computer-readable storage medium. Furthermore, the methods and apparatus described can be included in but are not limited to, application-specific integrated circuit (ASIC)
 40 chips, field-programmable gate arrays (FPGAs), and other programmable-logic devices.

We claim:

1. An apparatus to calibrate a clocked memory system,
 45 comprising:
 a calibration mechanism to perform a calibration operation at a first frequency to determine a first calibration state for a delay between a clock signal and a corresponding data signal in the clocked memory system;
 50 wherein the calibration mechanism is to use the first calibration state to determine a second calibration state, which is different than the first calibration state, for operation of the clocked memory system at a second frequency; and
 55 wherein the clocked memory system is to use the second calibration state when the clocked memory system is operating at the second frequency.
2. The apparatus of claim 1, embodied as a memory controller integrated circuit, wherein the memory controller integrated circuit is to transmit a write data word to a memory device via a data path external to the memory controller integrated circuit in order for the calibration mechanism to determine the first calibration state.
3. The apparatus of claim 1, wherein:
 65 the first calibration state includes a first pipeline delay component and a first offset component;

the second calibration state includes a second pipeline delay component and a second offset component;
 the calibration mechanism is to express each of the first pipeline delay component and the first offset component in increments related to a clock period for the clocked memory system; and

the calibration mechanism is to identify the second calibration state from the first calibration state by setting the second pipeline delay component to be equal to the first pipeline delay component and by setting the second propagation delay component to be equal to the first propagation delay component divided by a ratio between the first frequency and the second frequency.

4. The apparatus of claim 1, wherein:

the first calibration state includes a first pipeline delay component and a first offset component;

the second calibration state includes a second pipeline delay component and a second offset component; and

the calibration mechanism is to express each of the first pipeline delay component and the first offset component in increments of time; and

the calibration mechanism is to identify the second calibration state from the first calibration state by setting the second pipeline delay component to be equal to the first pipeline delay component multiplied by the ratio between the first frequency and the second frequency, and by setting the second offset component to be equal to the first offset component.

5. The apparatus of claim 4, wherein:

said apparatus further comprises at least one register; and the calibration mechanism is to store respective values for the first pipeline delay component and the first offset component in the at least one register, and is to store respective values for the second pipeline delay component and the second offset component in the at least one register for use when the clocked memory system is operating at the second frequency.

6. The apparatus of claim 1, wherein:

the calibration mechanism is to use the first calibration state to determine a third calibration state, which is different than the first calibration state and the second calibration state, for operation of the clocked memory system at a third frequency; and

the clocked memory system is to use the third calibration state when the clocked memory system is operating at the third frequency.

7. The apparatus of claim 6, wherein:

the second frequency is a first binary fraction of the first frequency, and the third frequency is a second binary fraction of the first frequency; and

the calibration mechanism is to determine each of the second calibration state and the third calibration state and is to store in at least one register respective values defining the respective second calibration state and third calibration state prior to operation of the clocked memory system at either of the second or third frequency which is in dependence on the respective, determined second calibration state or third calibration state.

8. The apparatus of claim 1, wherein:

the first calibration state includes a first pipeline delay component, the first pipeline delay component being treated as dependent on clock rate of the clocked memory system, and a first propagation delay component, the first propagation delay component being treated as independent of the clock rate; and

the second calibration state includes a second pipeline delay component, the second pipeline delay component

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being treated as dependent on the clock rate, and a second propagation delay component, the second pipeline delay component being treated as independent of the clock rate.

9. The apparatus of claim 8, wherein the first and second propagation delay components account for one or more of a driver delay, a channel delay, a receiver delay or a clock buffer delay.

10. The apparatus of claim 1, wherein the calibration operation is one of an initial calibration operation and a periodic calibration operation and the calibration mechanism is to responsively store a calibration value, and wherein the calibration mechanism is further to perform a drift tracking operation to increment or decrement the stored calibration value to adjust for change attributable to voltage or temperature drift in the clocked memory system.

11. The apparatus of claim 1, wherein the calibration mechanism is to perform the calibration operation to determine calibration components for each of a read path and a write path of the clocked memory system at the first frequency.

12. The apparatus of claim 1, wherein the calibration mechanism is to, for the second calibration state, identify a value for each of a word alignment and a phase offset between the clock signal and the data signal, and is to store said values in at least one register.

13. The apparatus of claim 1, wherein said apparatus is adapted to cause the clocked memory system to switch from operation at the second frequency to operation at the first frequency in order for the calibration mechanism to perform to the calibration operation and is adapted to cause the clocked memory system to switch back from operation at the first frequency to operation at the second frequency following performance of the calibration operation.

14. The apparatus of claim 1, wherein:

the calibration mechanism is to perform a calibration operation at the second frequency to update the second calibration state, and is to use the second calibration state to update the first calibration state; and the clocked memory system is to use the updated first calibration state when the clocked memory system is operating at the first frequency.

15. An apparatus to calibrate a clocked memory system, comprising:

a calibration mechanism to perform a calibration operation at a first frequency to determine a first calibration state for a delay between a clock signal and a corresponding data signal in the clocked memory system;

wherein

the calibration mechanism is to use the first calibration state to determine a second calibration state, which is different than the first calibration state, for operation of the clocked memory system at a second frequency, the clocked memory system is to use the second calibration state when the clocked memory system is operating at the second frequency,

the first calibration state includes a first pipeline delay component and a first offset component, and the second calibration state includes a second pipeline delay component and a second offset component, and

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the calibration mechanism is to identify the second calibration state from the first calibration state by one of

(1) setting the second pipeline delay component to be equal to the first pipeline delay component and setting the second propagation delay component to be equal to the first propagation delay component divided by a ratio between the first frequency and the second frequency, or

(2) setting the second propagation delay component to be equal to the first propagation delay component, and setting the second pipeline delay component to be equal to the first pipeline delay component multiplied by a ratio between the first frequency and the second frequency.

16. The apparatus of claim 15, wherein the calibration mechanism is to perform the calibration mechanism to determine calibration components for each of a read path and a write path of the clocked memory system at the first frequency.

17. The apparatus of claim 15, wherein the calibration mechanism is to, for the second calibration state, identify a value for each of a word alignment and a phase offset between the clock signal and the data signal, and is to store said values in at least one register.

18. The apparatus of claim 15, wherein said apparatus is to cause the clocked memory system to switch from operation at the second frequency to operation at the first frequency in order for the calibration mechanism to perform to the calibration operation and is to cause the clocked memory system to switch back from operation at the first frequency to operation at the second frequency following performance of the calibration operation.

19. The apparatus of claim 15, embodied as an integrated circuit.

20. An apparatus to calibrate a clocked memory system, comprising:

a calibration mechanism to perform a calibration operation at a first frequency to determine a first calibration state for a delay between a clock signal and a corresponding data signal in the clocked memory system;

wherein

the calibration mechanism is to use the first calibration state to determine a second calibration state, which is different than the first calibration state, for operation of the clocked memory system at a second frequency; the calibration mechanism is also to use the first calibration state to determine a third calibration state, which is different than each of the first calibration state and the second calibration state, for operation of the clocked memory system at a third frequency;

the clocked memory system is to use the second calibration state when the clocked memory system is operating at the second frequency, and the clocked memory system is to use the third calibration state when the clocked memory system is operating at the third frequency; and

the second and third frequencies are each less than the first frequency and are each respective fractions of the first frequency.

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